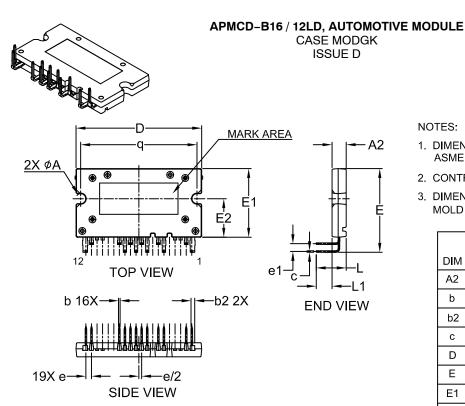
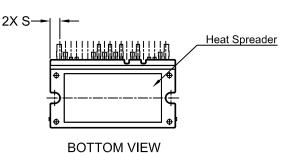


**DATE 04 NOV 2021** 





## NOTES:

- 1. DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION; MILLIMETERS
- 3. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

	MILLIMETERS		
DIM	MIN.	NOM.	MAX.
A2	4.30	4.50	4.70
b	0.45	0.50	0.60
b2	1.15	1.20	1.30
С	0.45	0.50	0.60
D	39.90	40.10	40.30
E	26.20	26.70	27.20
E1	21.70	21.90	22.10
E2	12.10	12.30	12.50
е	1.478	1.778	2.078
e1	2.20	2.50	2.80
L	9.20	9.55	9.90
L1	4.70	5.05	5.40
q	36.85	37.10	37.35
S	3.159 REF		
ØΑ	3.00	3.20	3.40

## **GENERIC MARKING DIAGRAM\***

XXXXXXXXXXXXXXX **777 ATYWW** NNNNNN

XXXX = Specific Device Code

ZZZ = Lot ID

ΑT = Assembly & Test Location

Υ = Year W = Work Week NNN = Serial Number \*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	SCRIPTION: APMCD-B16 / 12LD, AUTOMOTIVE MODULE		PAGE 1 OF 1

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